



ProLight PJ2E-2LxE-2
PJ2E-2LxE-N2R8
2W Power LED
Technical Datasheet
Version: 1.3

ProLight Opto ® PJ2E Series

Features

- High Color rendering index
- Good color uniformity
- Lead free reflow soldering
- RoHS compliant
- Instant light (less than 100ns)
- No UV

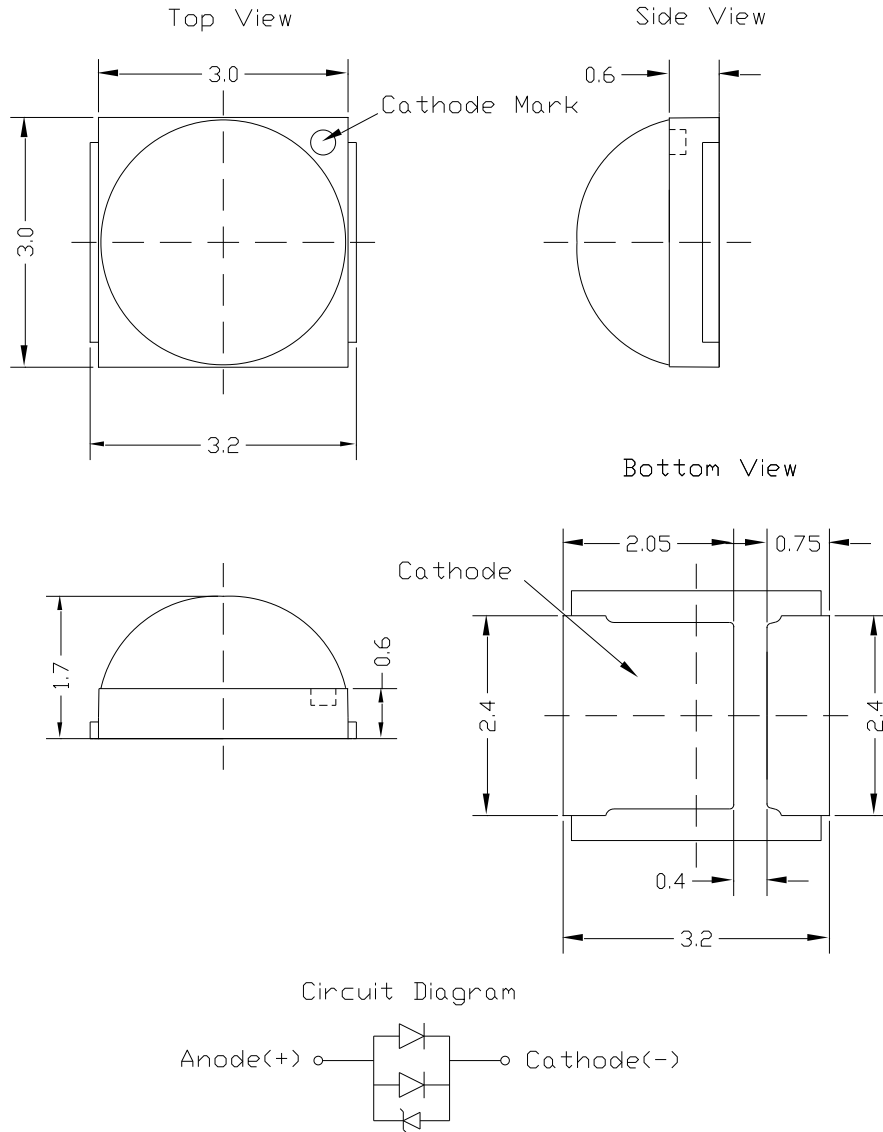
Main Applications

- T8/T5 tube
- LED bulb
- Indoor/Outdoor Commercial and Residential Architectural

Introduction

·PJ2E qualifies as the JEDEC Level 1 MSL sensitivity level and suitable for SMD process, Pb free reflow soldering capability, and full compliance with EU Reduction of Hazardous Substances (RoHS) legislation.

Emitter Mechanical Dimensions



Notes:

1. The cathode side of the device is denoted by the chamfer on the part body.
2. Drawing not to scale.
3. All dimensions are in millimeters.
4. Unless otherwise indicated, tolerances are $\pm 0.10\text{mm}$.
5. Please do not solder the emitter by manual hand soldering, otherwise it will damage the emitter.
6. **Please do not use a force of over 0.3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.**

*The appearance and specifications of the product may be modified for improvement without notice.

Flux Characteristics, $T_j = 25^{\circ}\text{C}$

Color	Part Number Emitter	Luminous Flux Φ_v (lm)			CRI Minimum
		$@300\text{mA}$ Minimum	Typical	Refer $@600\text{mA}$ Typical	
White	PJ2E-2LWE-2	120	145	262	70
Neutral White	PJ2E-2LNE-2	120	145	262	70
White	PJ2E-2LWE-N2R8	110	131	237	80
Neutral White	PJ2E-2LNE-N2R8	110	131	237	80
Warm White	PJ2E-2LVE-N2R8	100	122	221	80

- ProLight maintains a tolerance of $\pm 7\%$ on flux and power measurements.
- ProLight maintains a tolerance of ± 2 on CRI measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

Electrical Characteristics, $T_j = 25^{\circ}\text{C}$

Color	Forward Voltage V_F (V) $@300\text{mA}$			Forward Voltage V_F (V) Refer $@600\text{mA}$	Thermal Resistance Junction to Slug ($^{\circ}\text{C/W}$)
	Min.	Typ.	Max.	Typ.	
White	2.8	3.1	3.4	3.4	10
Neutral White	2.8	3.1	3.4	3.4	10
Warm White	2.8	3.1	3.4	3.4	10

- ProLight maintains a tolerance of $\pm 0.1\text{V}$ for Voltage measurements.

Optical Characteristics at 300mA, $T_j = 25^{\circ}\text{C}$

Radiation Pattern	Color	Color Temperature CCT			Total included Angle (degrees) $\theta_{0.90V}$	Viewing Angle (degrees) $2\theta_{1/2}$
		Min.	Typ.	Max.		
Lambertian	White	4745 K	5850 K	6950 K	170	130
	Neutral White	3700 K	3975 K	4250 K	170	130
	Warm White	2580 K	2900 K	3250 K	170	130

- ProLight maintains a tolerance of $\pm 5\%$ for CCT measurements.

Electro-Optical Characteristics, $T_j = 25^{\circ}\text{C}$

I_F (mA)	V_F (V)	Power (W)	PJ2E-2LWE-2		PJ2E-2LNE-2			
			Flux (lm)	lm/W	Flux (lm)	lm/W		
200	2.97	0.59	101	169.2	101	169.2		
250	3.04	0.76	123	162.1	123	162.1		
300	3.10	0.93	145	155.9	145	155.9		
350	3.15	1.10	166	150.5	166	150.5		
400	3.20	1.28	186	145.6	186	145.6		
500	3.30	1.65	225	136.3	225	136.3		
600	3.39	2.04	262	128.7	262	128.7		

I_F (mA)	V_F (V)	Power (W)	PJ2E-2LWE-N2R8		PJ2E-2LNE-N2R8		PJ2E-2LVE-N2R8	
			Flux (lm)	lm/W	Flux (lm)	lm/W	Flux (lm)	lm/W
200	2.97	0.59	91	152.9	91	152.9	85	142.4
250	3.04	0.76	111	146.4	111	146.4	104	136.4
300	3.10	0.93	131	140.9	131	140.9	122	131.2
350	3.15	1.10	150	136.0	150	136.0	140	126.6
400	3.20	1.28	168	131.5	168	131.5	157	122.5
500	3.30	1.65	203	123.1	203	123.1	189	114.7
600	3.39	2.04	237	116.3	237	116.3	221	108.3

● All values are reference only.

Absolute Maximum Ratings

Parameter	White/Neutral White/Warm White
DC Forward Current (mA)	600
Peak Pulsed Forward Current (mA)	700 (less than 1/10 duty cycle@1KHz)
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)	$\pm 4000\text{V}$ (Class III)
LED Junction Temperature	120°C
Operating Board Temperature at Maximum DC Forward Current	$-40^{\circ}\text{C} - 90^{\circ}\text{C}$
Storage Temperature	$-40^{\circ}\text{C} - 120^{\circ}\text{C}$
Soldering Temperature	JEDEC 020c 260°C
Allowable Reflow Cycles	3
Reverse Voltage	Not designed to be driven in reverse bias

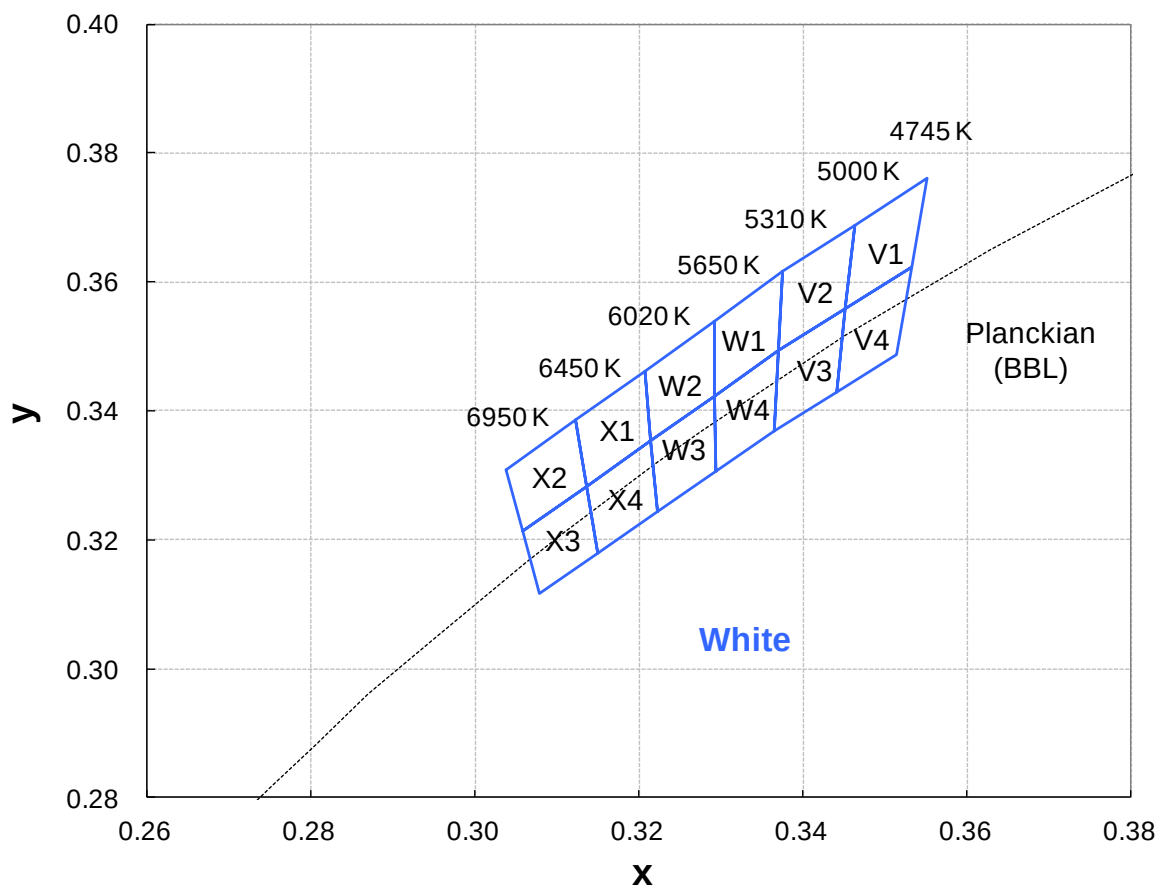
Photometric Luminous Flux Bin Structure at 300mA

Color	Bin Code	Minimum Photometric Flux (lm)	Maximum Photometric Flux (lm)	Available Color Bins
PJ2E-2LWE-2	V2	120	130	All
	W1	130	140	All
	W2	140	155	All
	X1	155	170	[¹]
PJ2E-2LNE-2	V2	120	130	All
	W1	130	140	All
	W2	140	155	All
	X1	155	170	[¹]
PJ2E-2LWE-N2R8	V1	110	120	All
	V2	120	130	All
	W1	130	140	All
	W2	140	155	[¹]
PJ2E-2LNE-N2R8	V1	110	120	All
	V2	120	130	All
	W1	130	140	All
	W2	140	155	[¹]
PJ2E-2LVE-N2R8	U2	100	110	All
	V1	110	120	All
	V2	120	130	Nx [¹]
	W1	130	140	[¹]

- ProLight maintains a tolerance of $\pm 7\%$ on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- [¹] The rest of color bins are not 100% ready for order currently. Please ask for quote and order Possibility.

Color Bin

White Binning Structure Graphical Representation



Color Bin

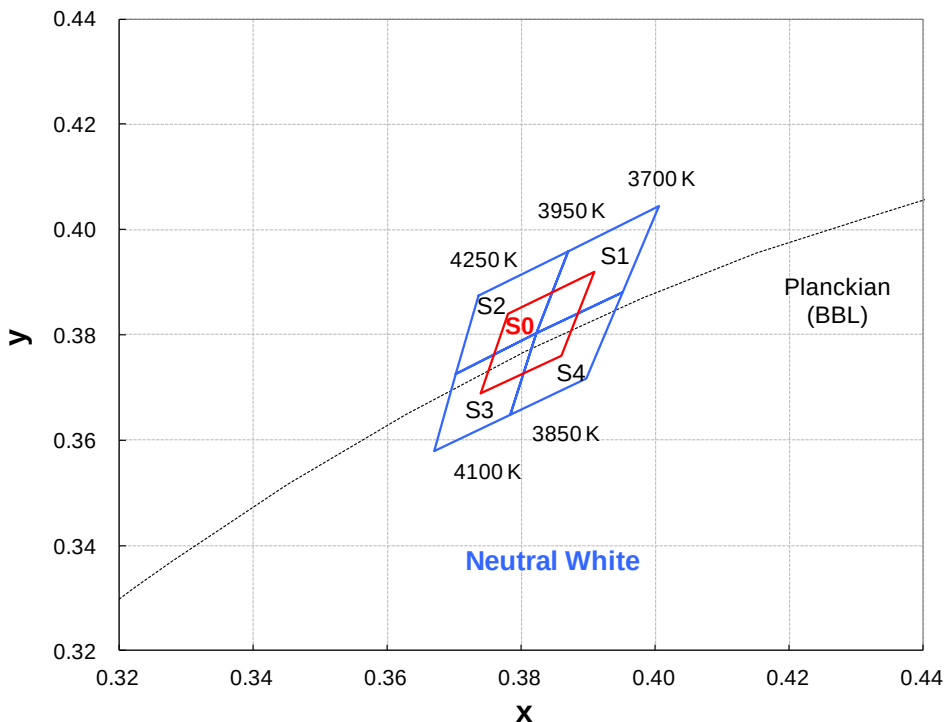
White Bin Structure

Bin Code	x	y	Typ. CCT (K)	Bin Code	x	y	Typ. CCT (K)
V1	0.3464	0.3688	4870	W2	0.3207	0.3462	5830
	0.3551	0.3760			0.3292	0.3539	
	0.3533	0.3624			0.3293	0.3423	
	0.3452	0.3558			0.3215	0.3353	
V4	0.3452	0.3558	4870	W3	0.3215	0.3353	5830
	0.3533	0.3624			0.3293	0.3423	
	0.3515	0.3487			0.3294	0.3306	
	0.3441	0.3428			0.3222	0.3243	
V2	0.3376	0.3616	5155	X1	0.3123	0.3385	6240
	0.3464	0.3688			0.3207	0.3462	
	0.3452	0.3558			0.3215	0.3353	
	0.3371	0.3493			0.3136	0.3283	
V3	0.3371	0.3493	5155	X4	0.3136	0.3283	6240
	0.3452	0.3558			0.3215	0.3353	
	0.3441	0.3428			0.3222	0.3243	
	0.3366	0.3369			0.3150	0.3180	
W1	0.3292	0.3539	5475	X2	0.3038	0.3308	6700
	0.3376	0.3616			0.3123	0.3385	
	0.3371	0.3493			0.3136	0.3283	
	0.3293	0.3423			0.3058	0.3213	
W4	0.3293	0.3423	5475	X3	0.3058	0.3213	6700
	0.3371	0.3493			0.3136	0.3283	
	0.3366	0.3369			0.3150	0.3180	
	0.3294	0.3306			0.3078	0.3117	

- Tolerance on each color bin (x , y) is ± 0.005

Color Bin

Neutral White Binning Structure Graphical Representation



Neutral White Bin Structure

Bin Code	x	y	Typ. CCT (K)	Bin Code	x	y	Typ. CCT (K)
S1	0.3871	0.3959	3825	S2	0.3736	0.3874	4100
	0.4006	0.4044			0.3871	0.3959	
	0.3952	0.3880			0.3823	0.3803	
	0.3823	0.3803			0.3703	0.3726	
S4	0.3823	0.3803	3825	S3	0.3703	0.3726	4100
	0.3952	0.3880			0.3823	0.3803	
	0.3898	0.3716			0.3784	0.3647	
	0.3784	0.3647			0.3670	0.3578	
S0	0.3740	0.3690	3975				
	0.3780	0.3840					
	0.3910	0.3920					
	0.3860	0.3760					

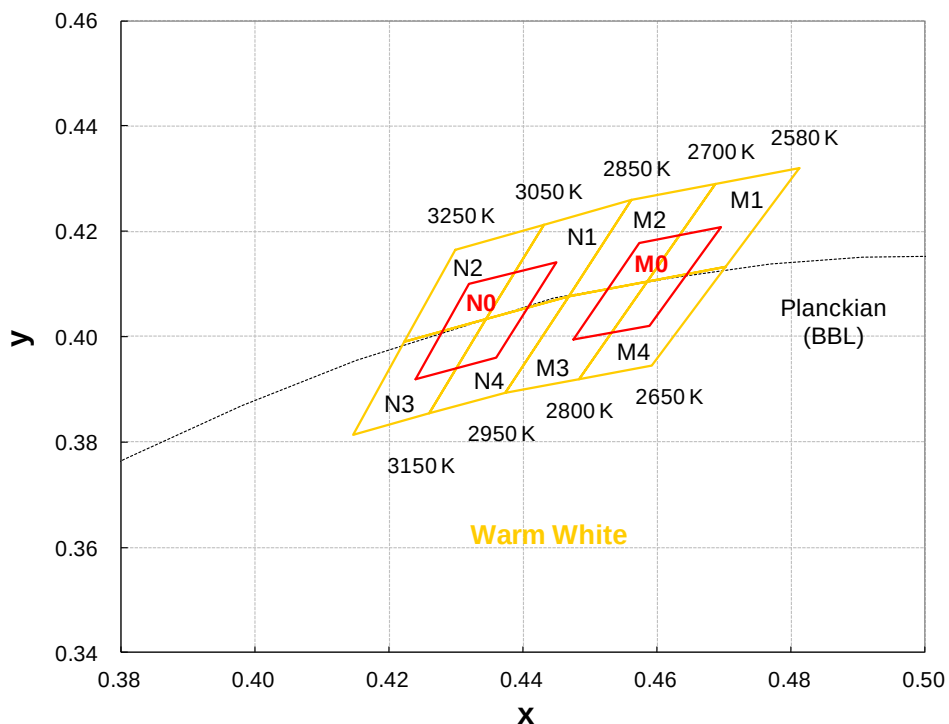
- Tolerance on each color bin (x , y) is ± 0.005

Note:

1. Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.
2. ProLight **SmartBin** is working to make the color bin smarter, by selecting that intelligence is infused into major **S0** bin with minor S1-S4 bins and processes that make assembly easily

Color Bin

Warm White Binning Structure Graphical Representation



Color Bin

Warm White Bin Structure

Bin Code	x	y	Typ. CCT (K)	Bin Code	x	y	Typ. CCT (K)
M1	0.481	0.432	2650	N1	0.443	0.421	2950
	0.469	0.429			0.456	0.426	
	0.459	0.410			0.447	0.408	
	0.470	0.413			0.435	0.403	
M4	0.470	0.413	2650	N4	0.435	0.403	2950
	0.459	0.410			0.447	0.408	
	0.448	0.392			0.437	0.389	
	0.459	0.394			0.426	0.385	
M0	0.448	0.399	2700	N0	0.424	0.392	3050
	0.457	0.418			0.432	0.410	
	0.470	0.421			0.445	0.414	
	0.459	0.402			0.436	0.396	
M2	0.469	0.429	2800	N2	0.430	0.417	3150
	0.456	0.426			0.443	0.421	
	0.447	0.408			0.435	0.403	
	0.459	0.410			0.422	0.399	
M3	0.459	0.410	2800	N3	0.422	0.399	3150
	0.447	0.408			0.435	0.403	
	0.437	0.389			0.426	0.385	
	0.448	0.392			0.415	0.381	

- Tolerance on each color bin (x , y) is ± 0.005

Note:

1. Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.
2. ProLight **SmartBin** is working to make the color bin smarter, by selecting that intelligence is infused into major **M0 , N0** bin with minor M1-M4 , N1-N4 bins and processes that make assembly easily

Forward Voltage Bin Structure at 300mA

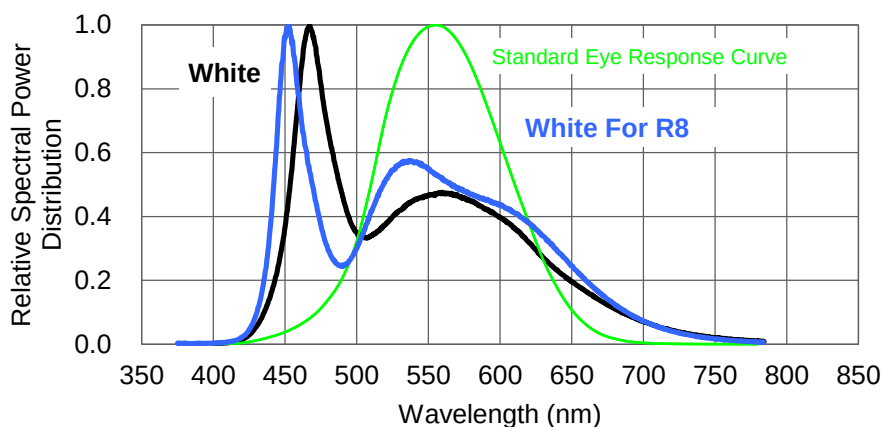
Color	Bin Code	Minimum Voltage (V)	Maximum Voltage (V)
White	A	2.8	2.9
	B	2.9	3.0
	D	3.0	3.1
	E	3.1	3.2
	F	3.2	3.3
	G	3.3	3.4
Neutral White	A	2.8	2.9
	B	2.9	3.0
	D	3.0	3.1
	E	3.1	3.2
	F	3.2	3.3
	G	3.3	3.4
Warm White	A	2.8	2.9
	B	2.9	3.0
	D	3.0	3.1
	E	3.1	3.2
	F	3.2	3.3
	G	3.3	3.4

- ProLight maintains a tolerance of $\pm 0.1V$ for Voltage measurements.

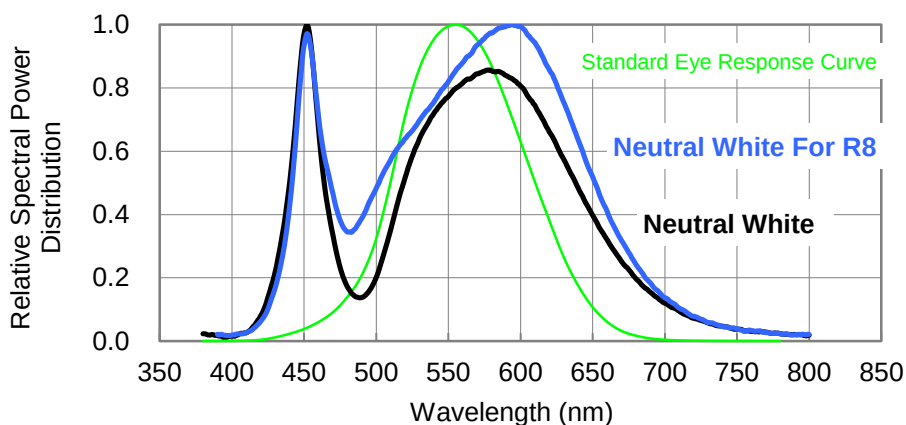
Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Color Spectrum, $T_1 = 25^{\circ}\text{C}$

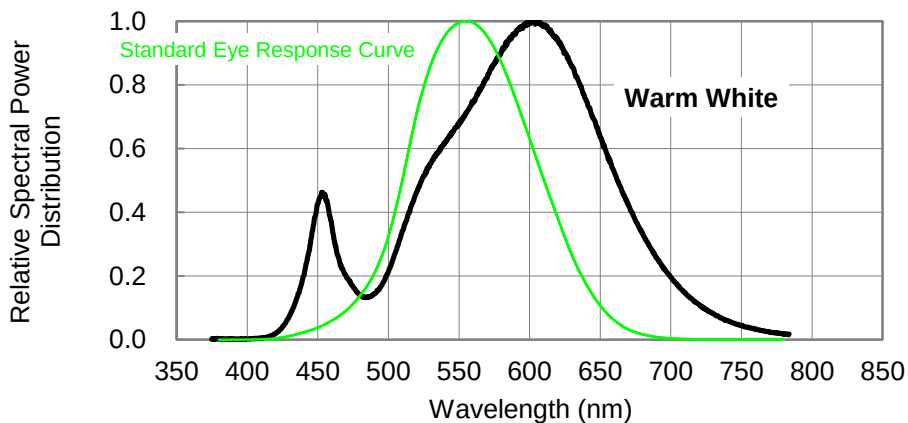
1. White



2. Neutral White

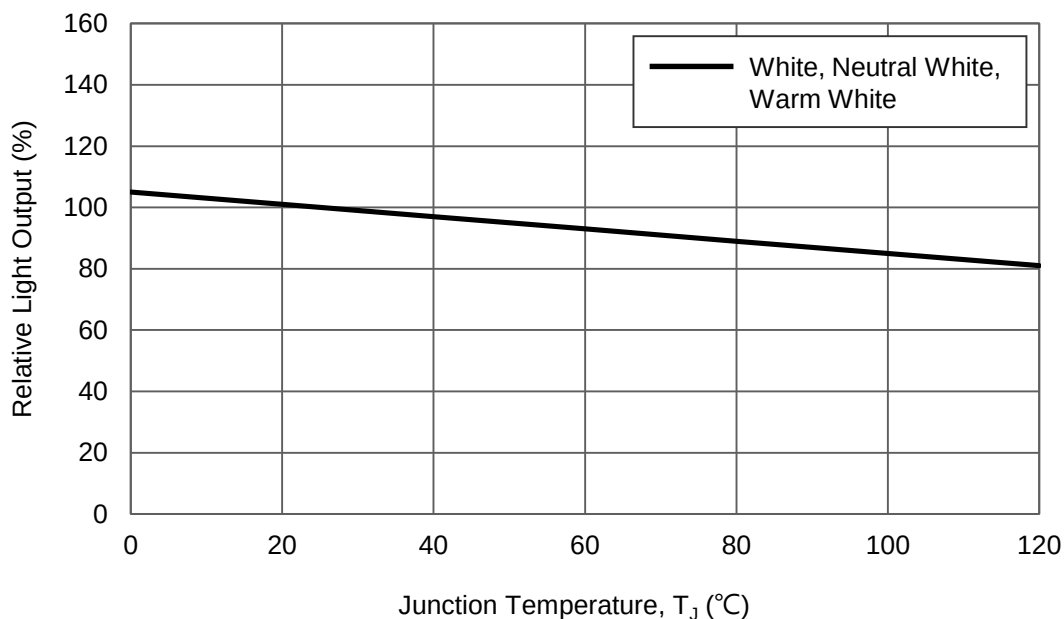


3. Warm White

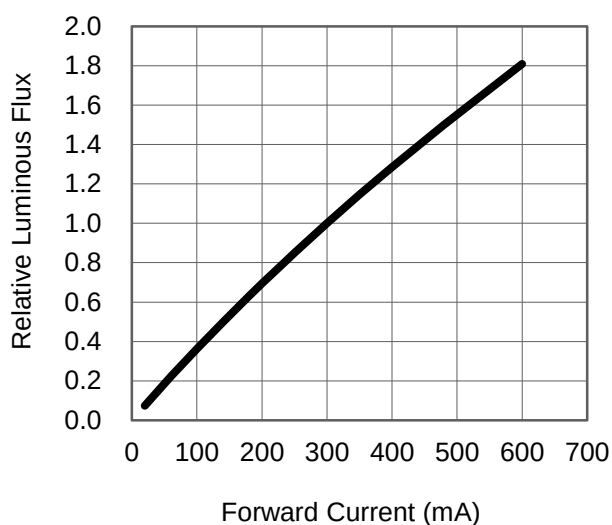
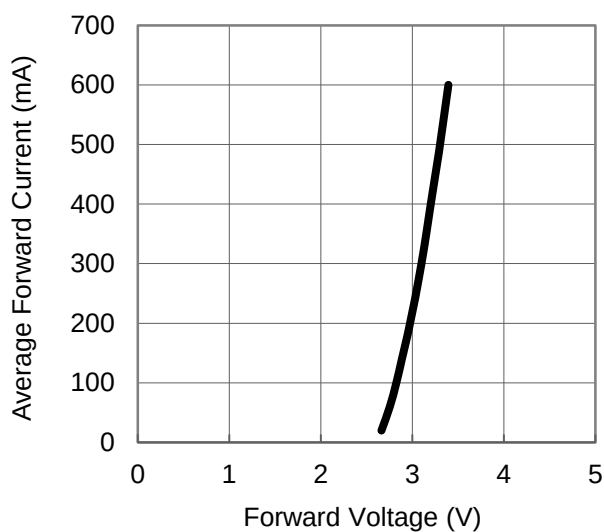


Light Output Characteristics

Relative Light Output vs. Junction Temperature at 600mA

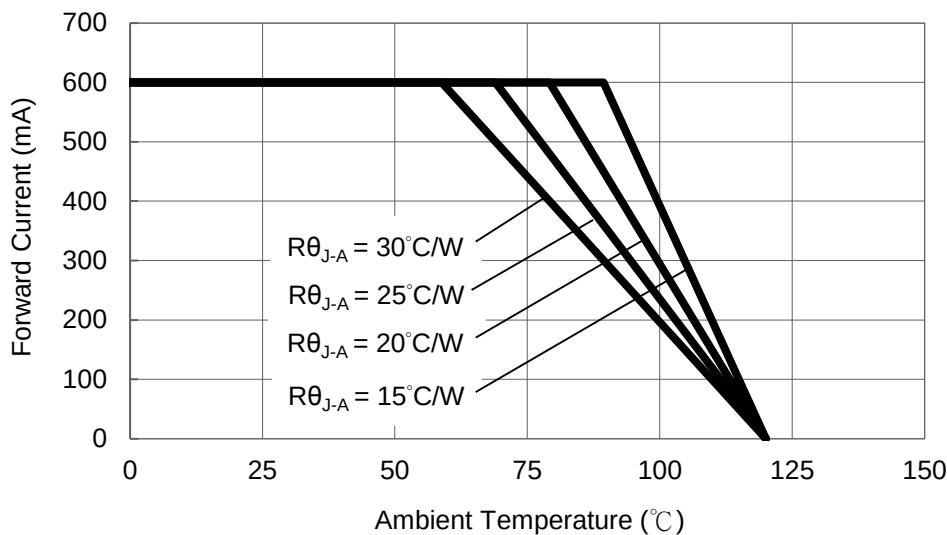


Forward Current Characteristics, $T_j = 25^\circ\text{C}$



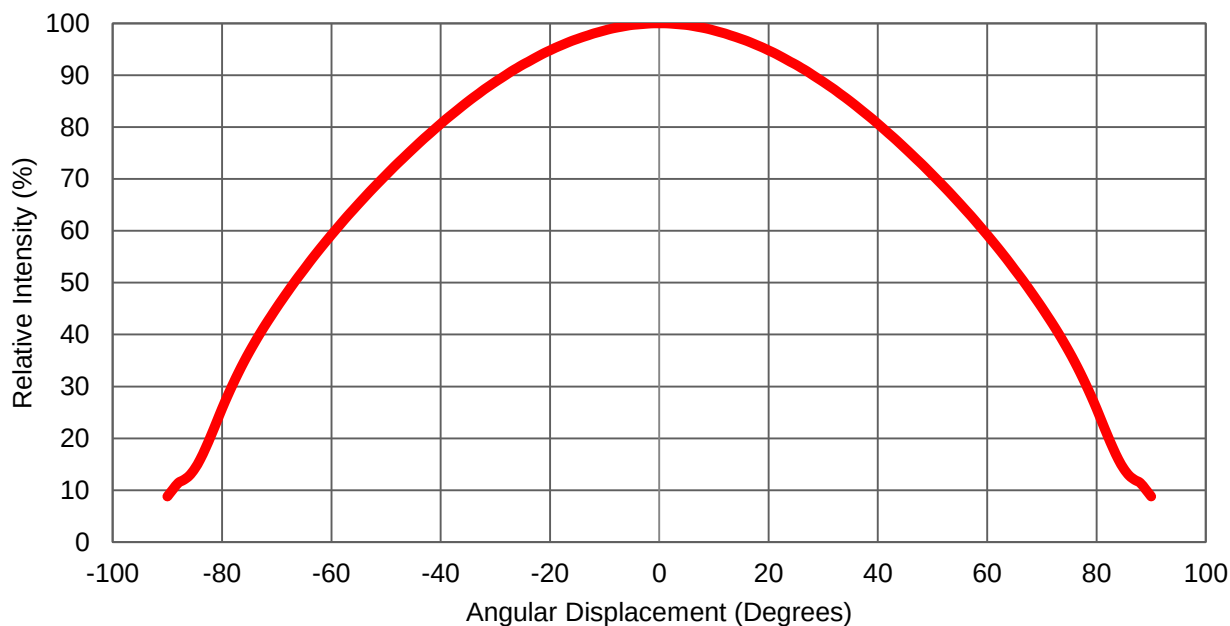
Ambient Temperature vs. Maximum Forward Current

1. White, Neutral White, Warm White ($T_{JMAX} = 120^{\circ}\text{C}$)



Typical Representative Spatial Radiation Pattern

Lambertian Radiation Pattern



Moisture Sensitivity Level - JEDEC Level 1

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	$\leq 30^{\circ}\text{C}$ / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA

- The standard soak time includes a default value of 24 hours for semiconductor manufacture's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	$\leq 30^{\circ}\text{C}$ / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA
2	1 year	$\leq 30^{\circ}\text{C}$ / 60% RH	168 +5/-0	85°C / 60% RH	NA	NA
2a	4 weeks	$\leq 30^{\circ}\text{C}$ / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH
3	168 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	192 +5/-0	30°C / 60% RH	40 +1/-0	60°C / 60% RH
4	72 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	96 +2/-0	30°C / 60% RH	20 +0.5/-0	60°C / 60% RH
5	48 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	72 +2/-0	30°C / 60% RH	15 +0.5/-0	60°C / 60% RH
5a	24 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	48 +2/-0	30°C / 60% RH	10 +0.5/-0	60°C / 60% RH
6	Time on Label (TOL)	$\leq 30^{\circ}\text{C}$ / 60% RH	Time on Label (TOL)	30°C / 60% RH	NA	NA

Qualification Reliability Testing

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life (RTOL)	25°C, I_F = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Operating Life (WHTOL)	85°C/60%RH, I_F = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Storage Life (WHTSL)	85°C/85%RH, non-operating	1000 hours	Note 2
High Temperature Storage Life (HTSL)	110°C, non-operating	1000 hours	Note 2
Low Temperature Storage Life (LTSL)	-40°C, non-operating	1000 hours	Note 2
Non-operating Temperature Cycle (TMCL)	-40°C to 120°C, 30 min. dwell, <5 min. transfer	200 cycles	Note 2
Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis		Note 3
Natural Drop	On concrete from 1.2 m, 3X		Note 3
Variable Vibration Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis		Note 3
Solder Heat Resistance (SHR)	260°C $\pm$ 5°C, 10 sec.		Note 3
Solderability	Steam age for 16 hrs., then solder dip at 260°C for 5 sec.		Solder coverage on lead

Notes:

1. Depending on the maximum derating curve.
2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement	
		Min.	Max.
Forward Voltage (V_F)	I_F = max DC	--	Initial Level x 1.1
Luminous Flux or Radiometric Power (Φ_V)	I_F = max DC	Initial Level x 0.7	--

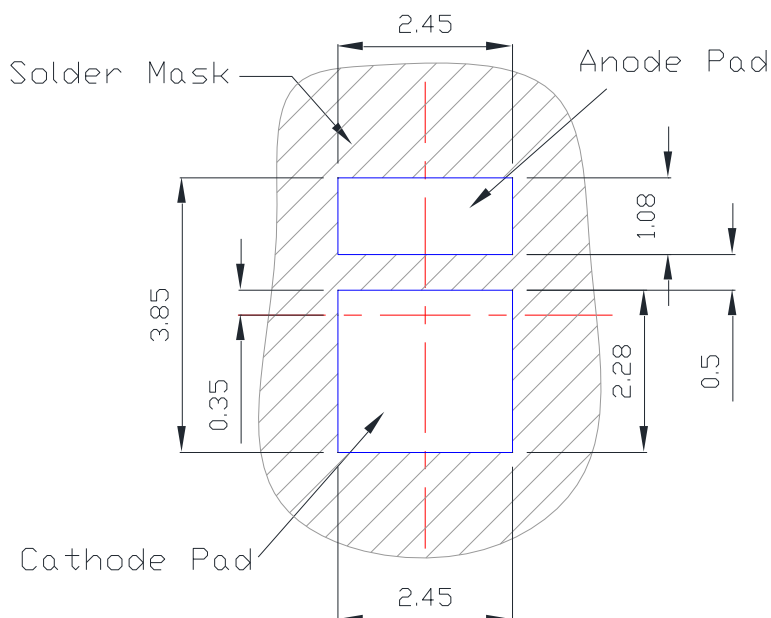
* The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

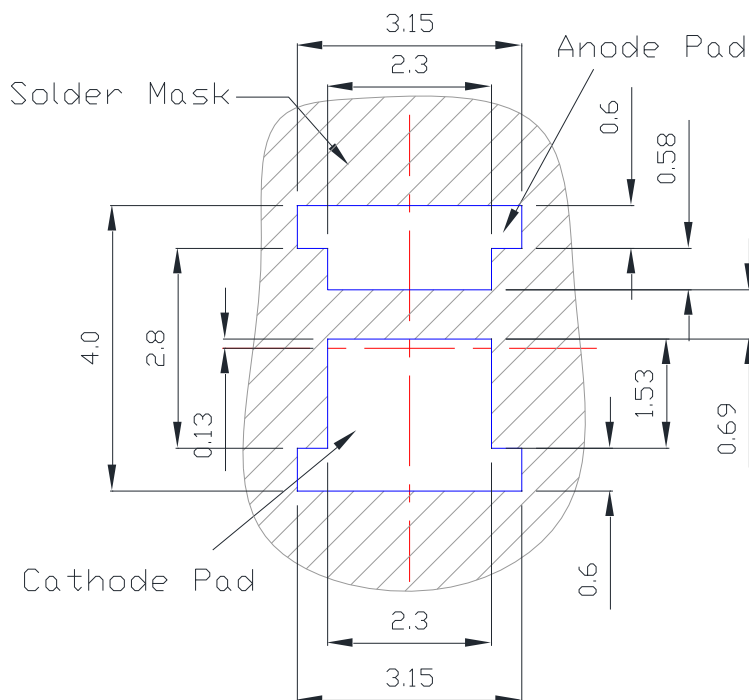
Recommended Solder Pad Design

Standard Emitter

TYPE A.



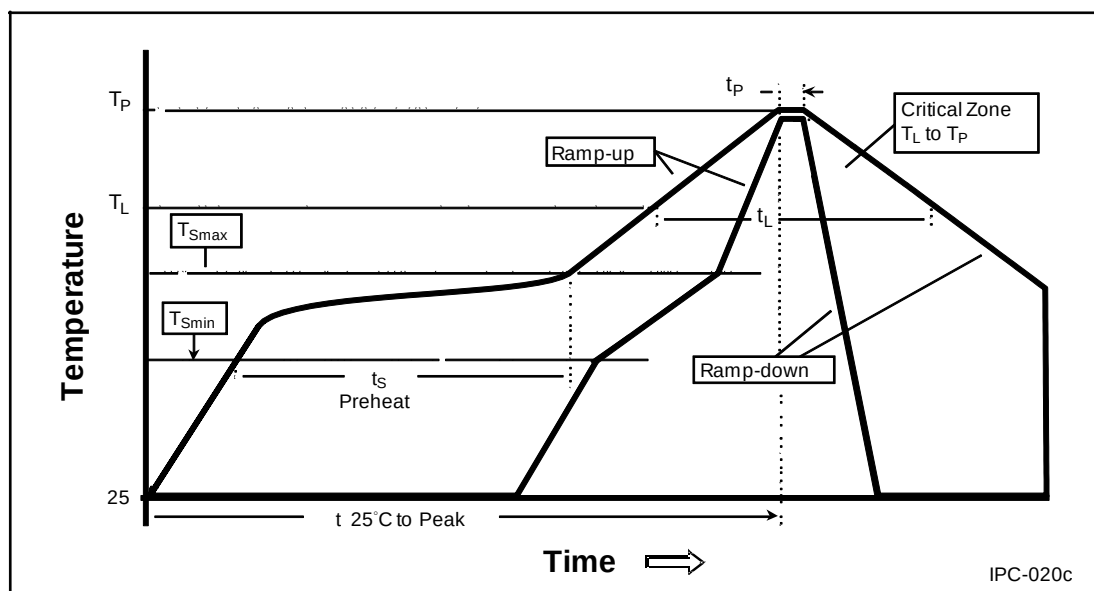
TYPE B.



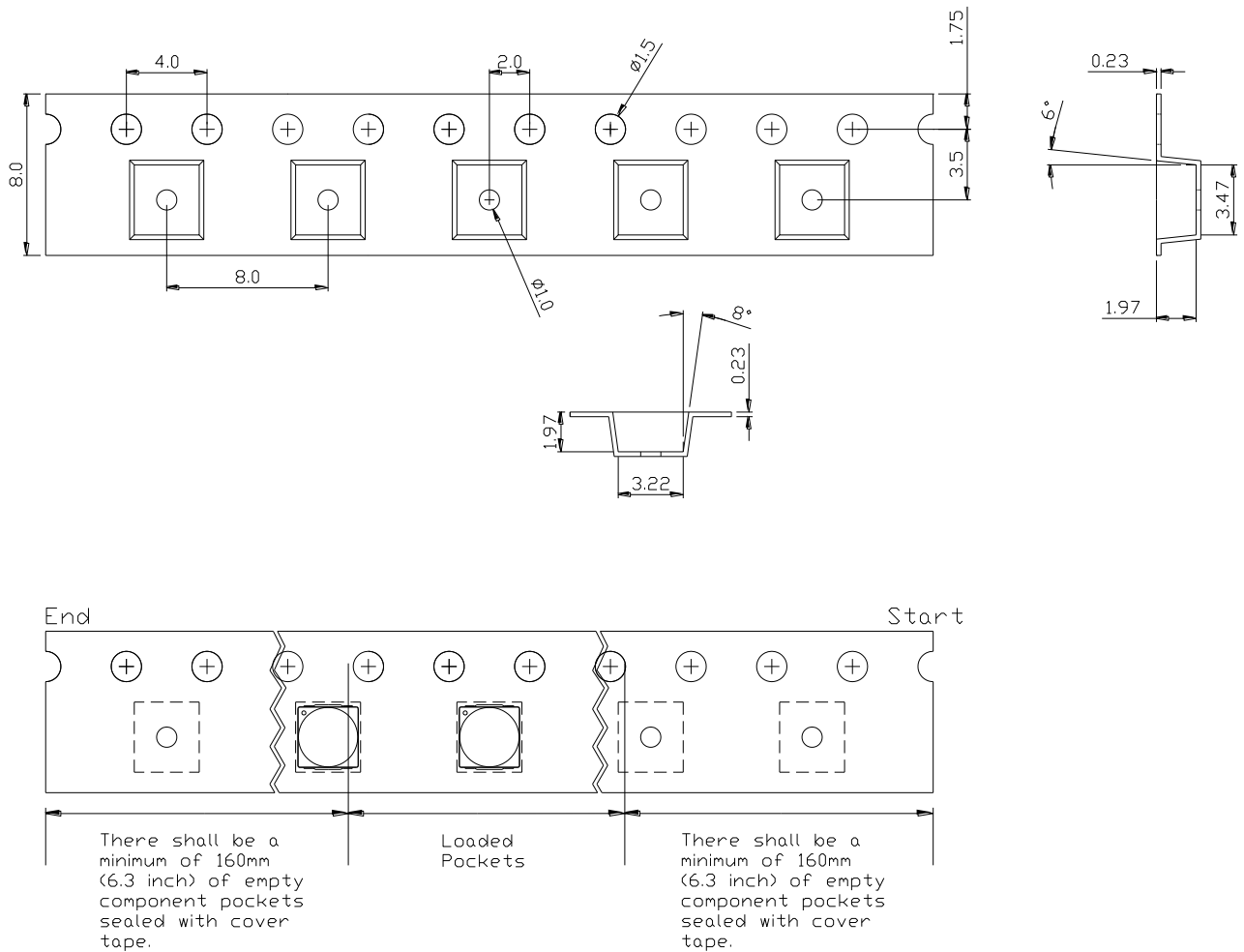
- All dimensions are in millimeters.

Reflow Soldering Condition

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-Up Rate (T_{Smax} to T_p)	3°C / second max.	3°C / second max.
Preheat – Temperature Min (T_{Smin}) – Temperature Max (T_{Smax}) – Time (t_{Smin} to t_{Smax})	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: – Temperature (T_L) – Time (t_L)	183°C 60-150 seconds	217°C 60-150 seconds
Peak/Classification Temperature (T_p)	240°C	260°C
Time Within 5°C of Actual Peak Temperature (t_p)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue > 47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

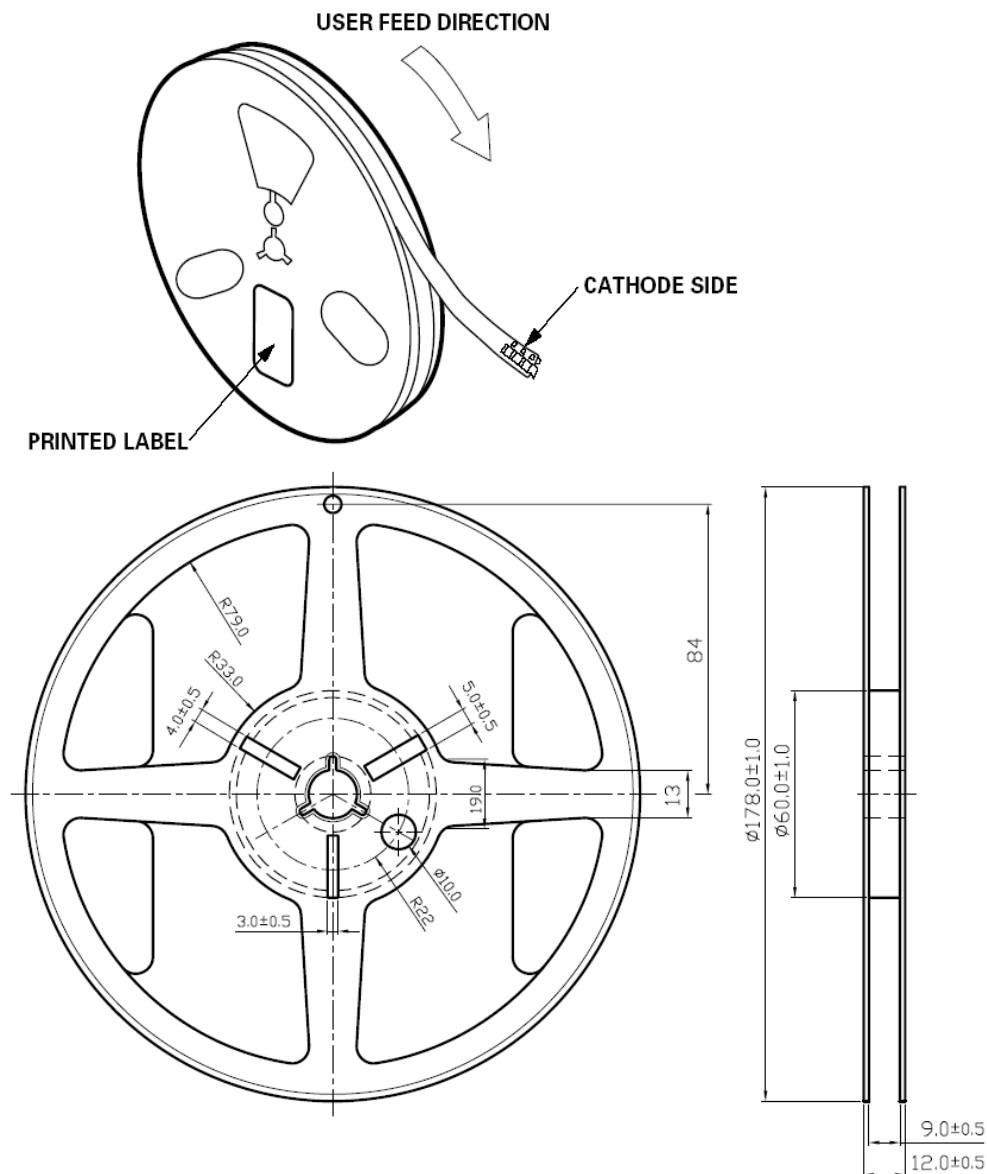


Notes:

1. Drawing not to scale.
2. All dimensions are in millimeters.
3. Unless otherwise indicated, tolerances are ± 0.10 mm.



Emitter Reel Packaging



Notes:

1. Empty component pockets sealed with top cover tape.
2. 1000 pieces per reel.
3. Drawing not to scale.
4. All dimensions are in millimeters.

Precaution for Use

- Storage
Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30 °C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseat the MBB.
- The slug is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- **We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.**
- **Do not use solder pastes with post reflow flux residue > 47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.**
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decided after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets.
<http://www.prolightopto.com/>

Handling of Silicone LEDs

Notes for handling of silicone LEDs

- Please do not use a force of over 0.3kgf impact or pressure on the silicone, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the silicone especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the silicone.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the silicone lens must be prevented.
- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)

